

Fig. 3

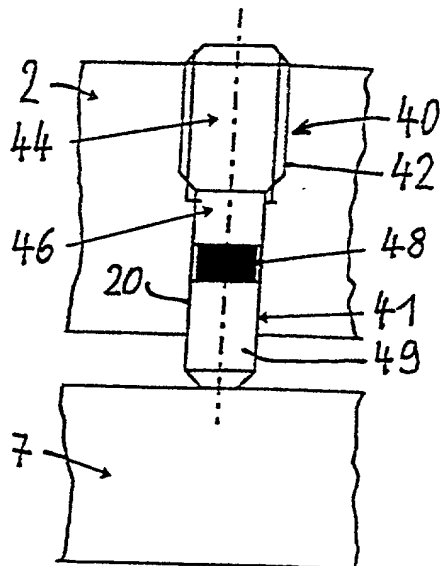


Fig. 4

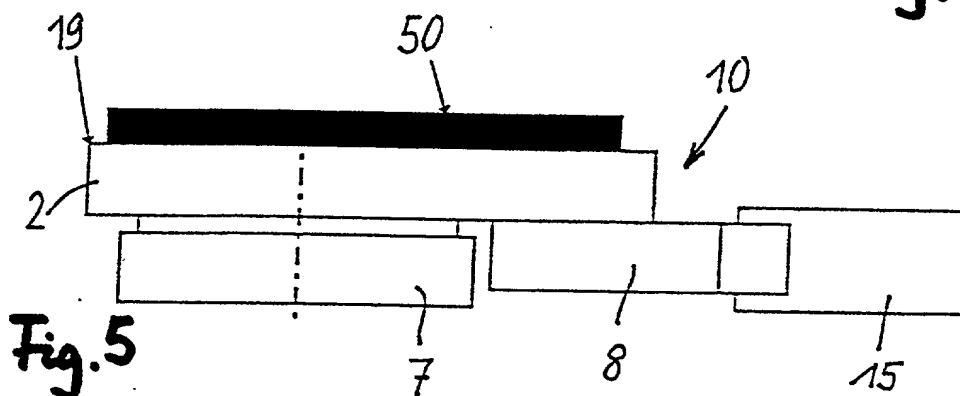


Fig. 5

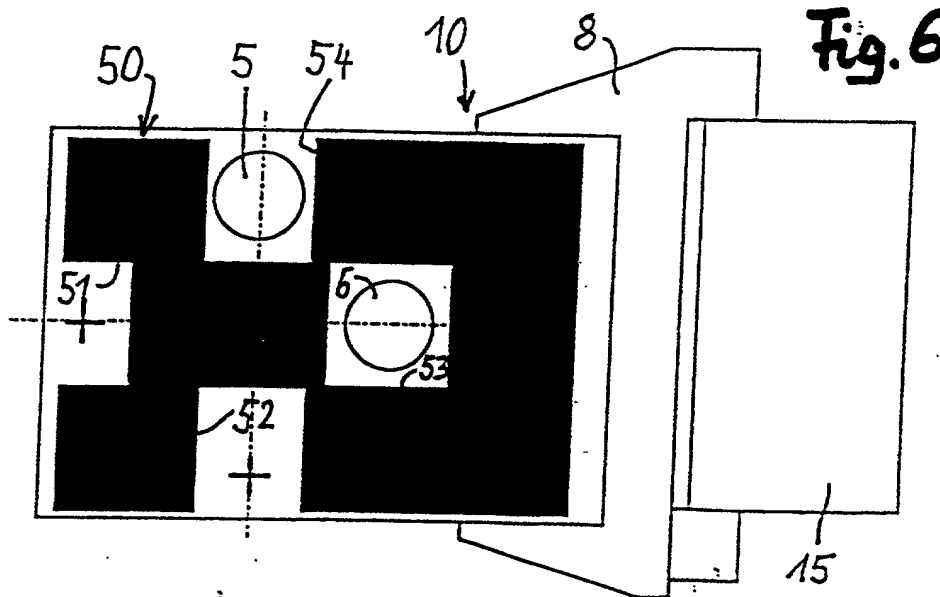
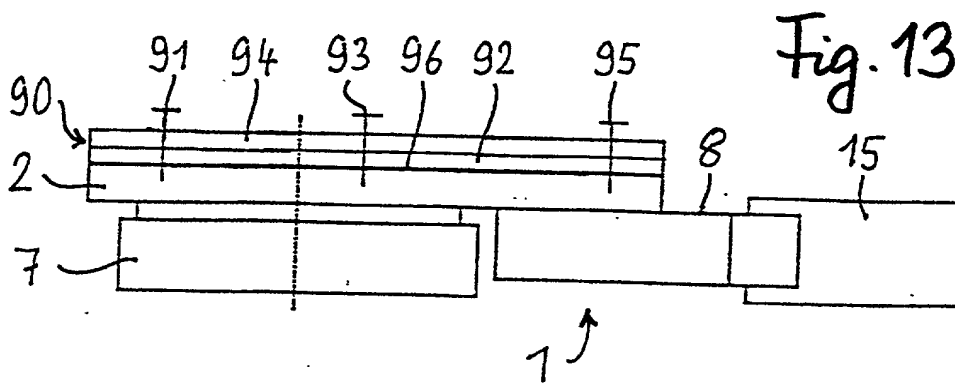
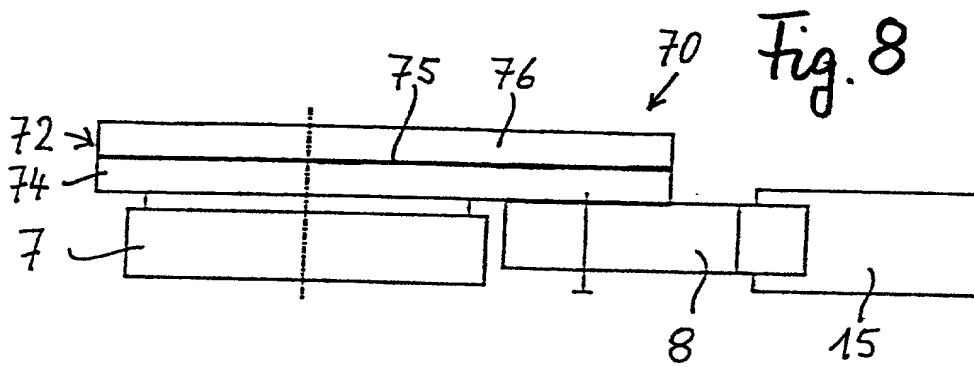
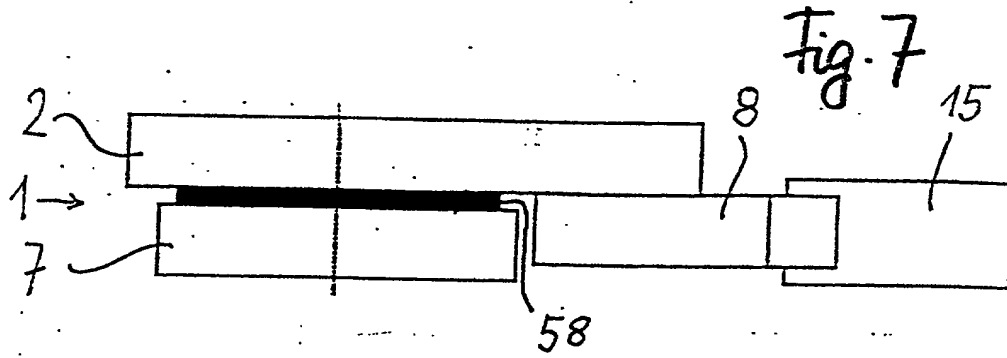


Fig. 6



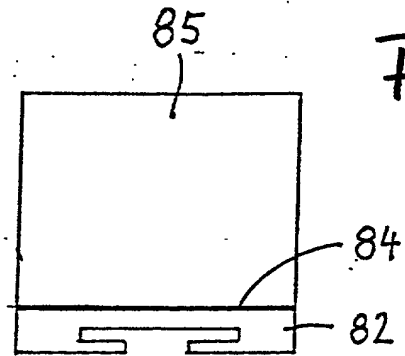


Fig. 9

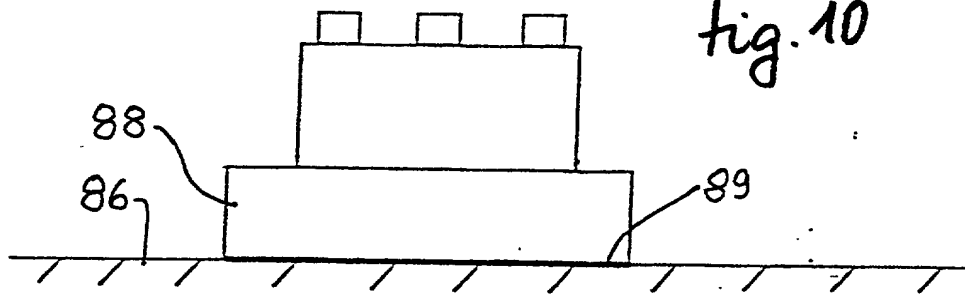


Fig. 10

Fig. 12

Fig. 12 is a cross-sectional view of a device assembly. A main rectangular block (2) contains two circular features (5 and 6) aligned vertically. A horizontal dashed line with cross-ticks passes through feature 6. A vertical dashed line with cross-ticks passes through feature 5. On the right side of block 2, there is a top layer (60) and a bottom layer (65). Between these layers is a thin layer (61) and a thicker layer (62). A vertical component (8) is attached to the right side of block 2. To the right of component 8 is another rectangular block (15). Various other labels (63, 24, 26, 68, 66, 67) point to specific features and layers within the assembly.

Fig. 14

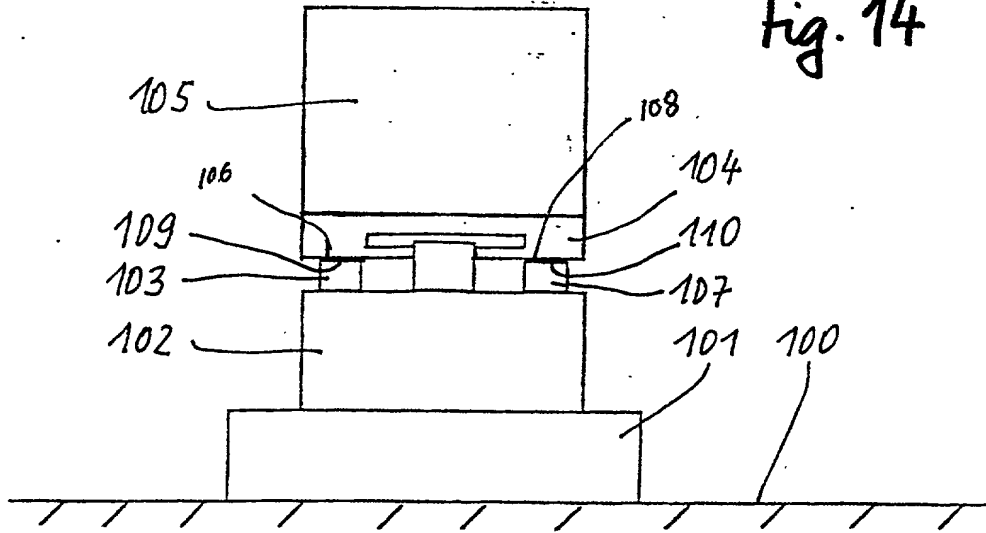
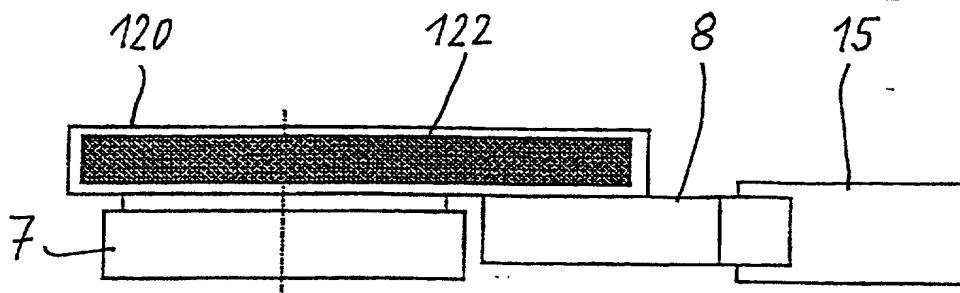


Fig. 15



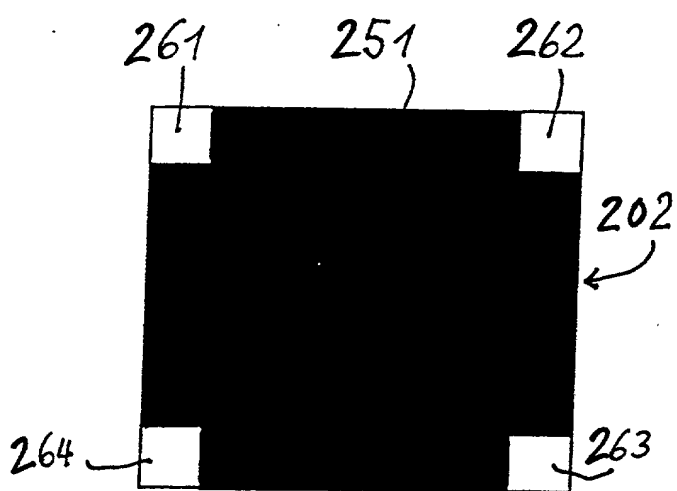
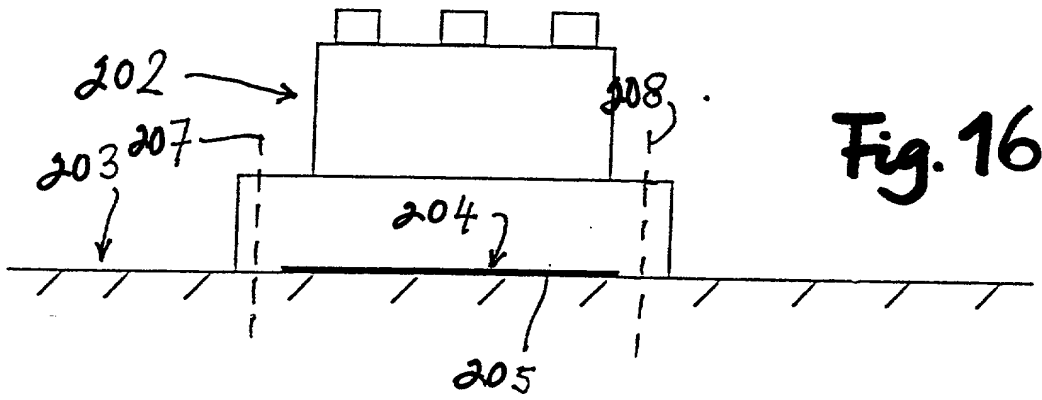
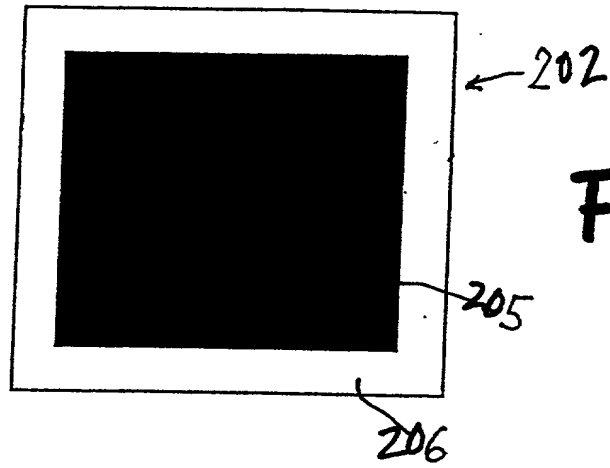


Fig. 19

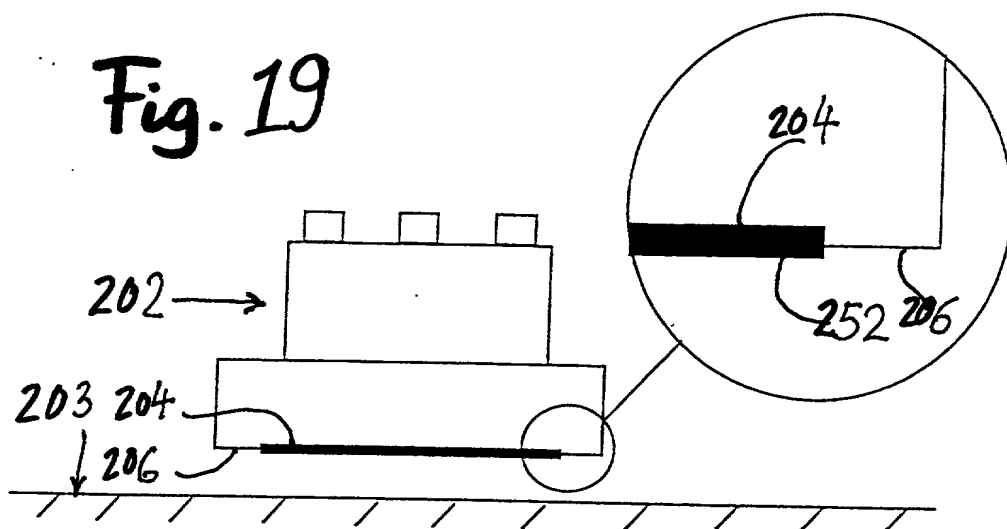


Fig. 20

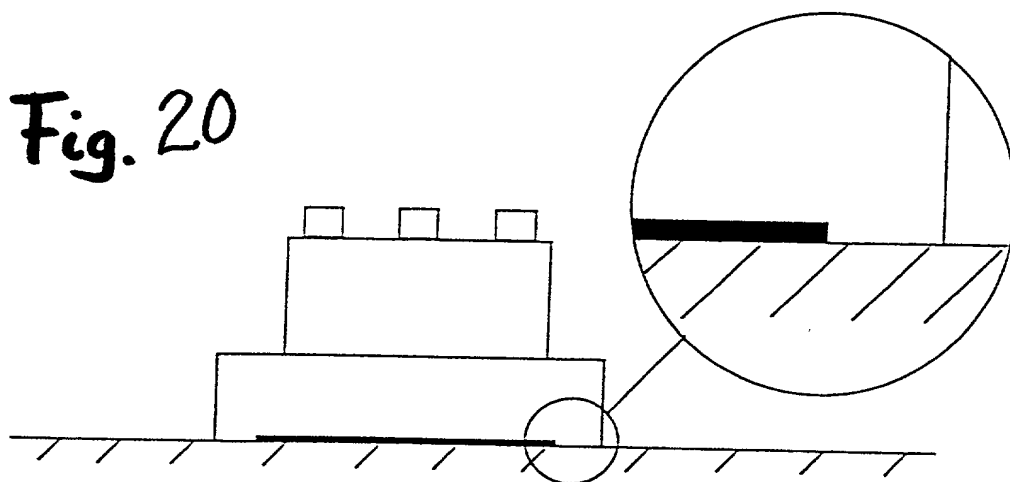


Fig. 23

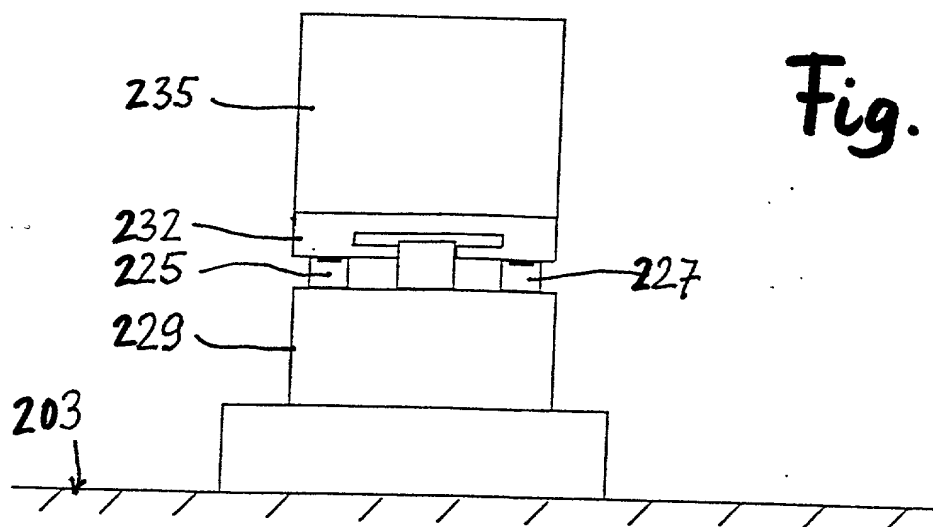


Fig. 21

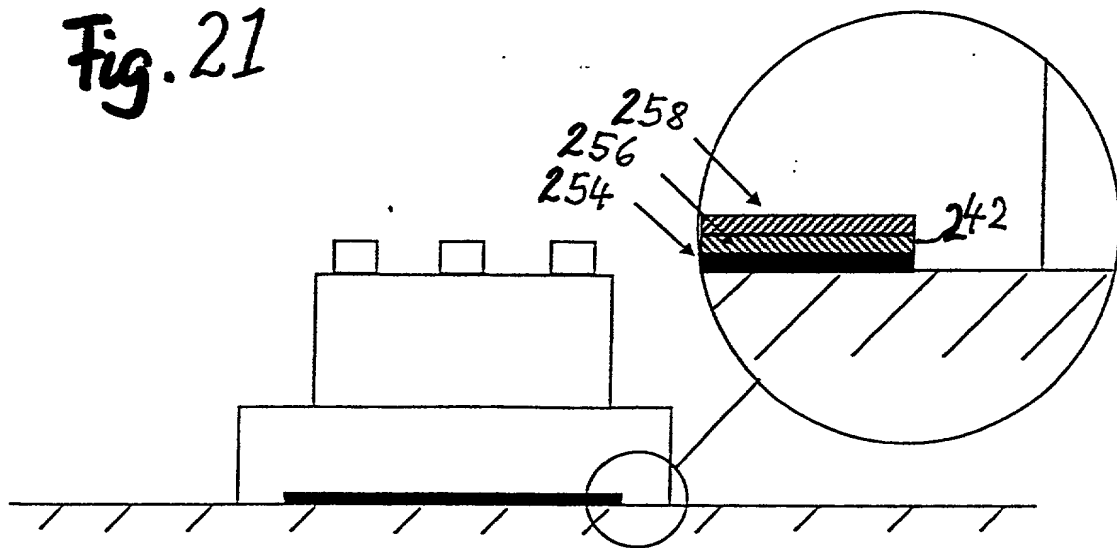


Fig. 22

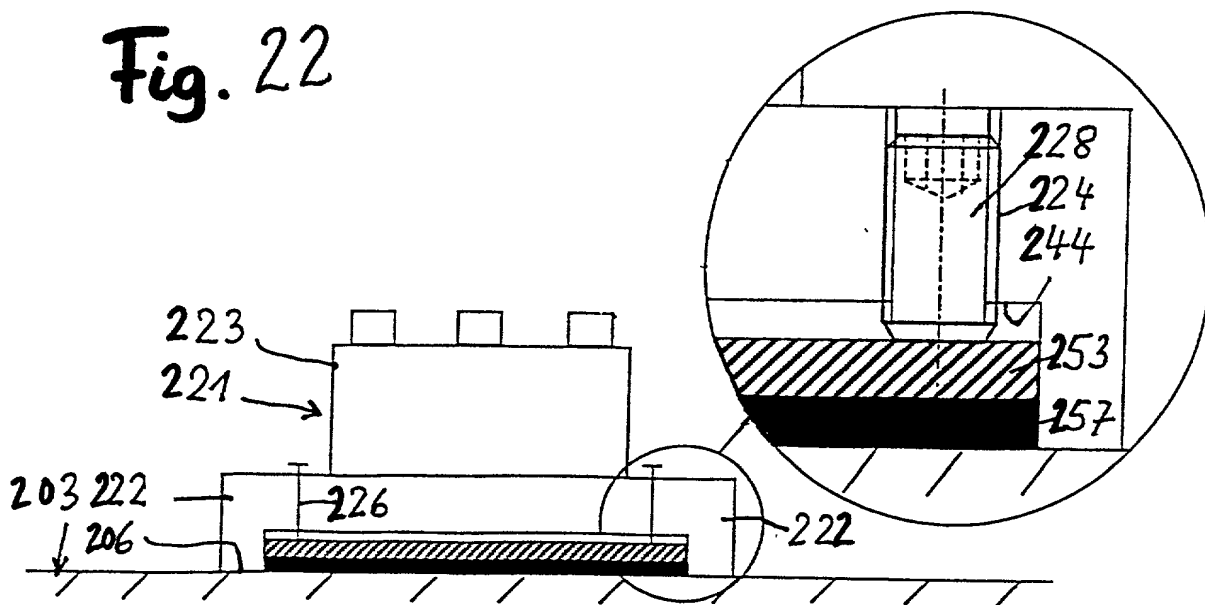


Fig. 24

